

# MSG43002

## SiGe HBT type

For low-noise RF amplifier

### ■ Features

- Compatible between high breakdown voltage and high cutoff frequency
- Low-noise, high-gain amplification
- Suitable for high-density mounting and downsizing of the equipment for Ultraminiature leadless package  
0.6 mm × 1.0 mm (height 0.39 mm)

### ■ Absolute Maximum Ratings $T_a = 25^\circ\text{C}$

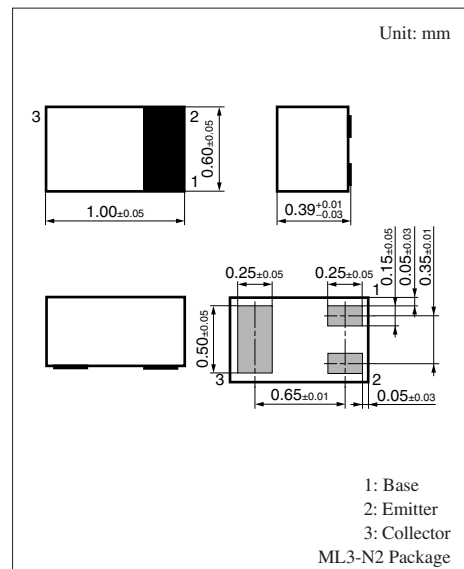
Parameter	Symbol	Rating	Unit
Collector-base voltage (Emitter open)	$V_{\text{CBO}}$	9	V
Collector-emitter voltage (Base open)	$V_{\text{CEO}}$	6	V
Emitter-base voltage (Collector open)	$V_{\text{EBO}}$	1	V
Collector current	$I_{\text{C}}$	60	mA
Collector power dissipation*	$P_{\text{C}}$	100	mW
Junction temperature	$T_{\text{j}}$	125	$^\circ\text{C}$
Storage temperature	$T_{\text{stg}}$	-55 to +125	$^\circ\text{C}$

Note) \*: Copper plate at the collector is 5.0 cm<sup>2</sup> on substrate at 10 mm × 12 mm × 0.8 mm.

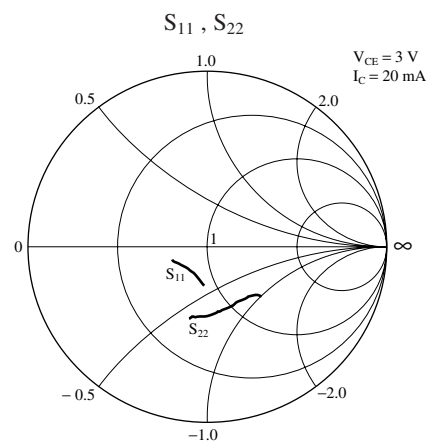
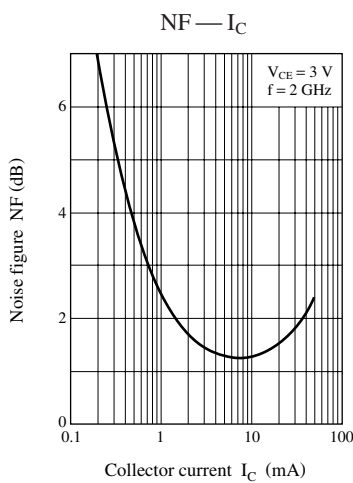
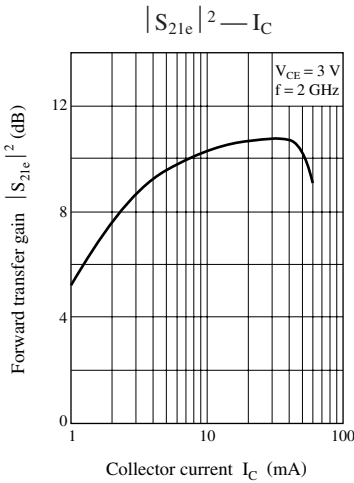
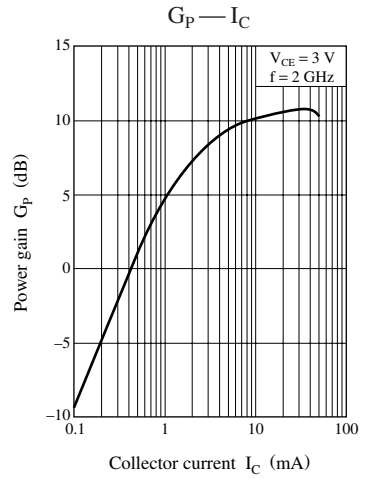
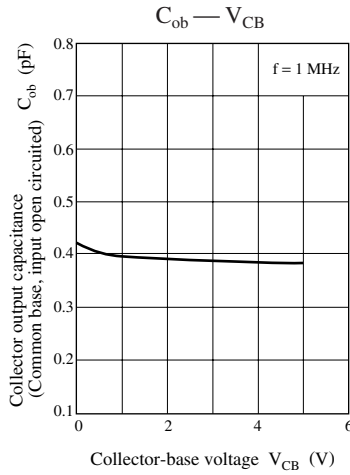
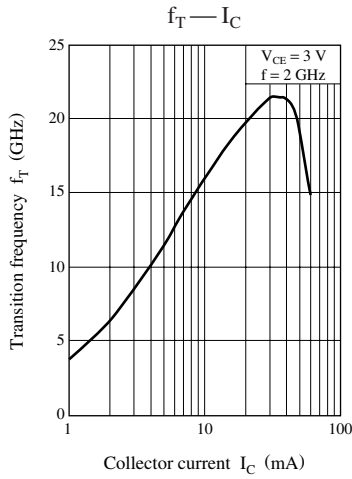
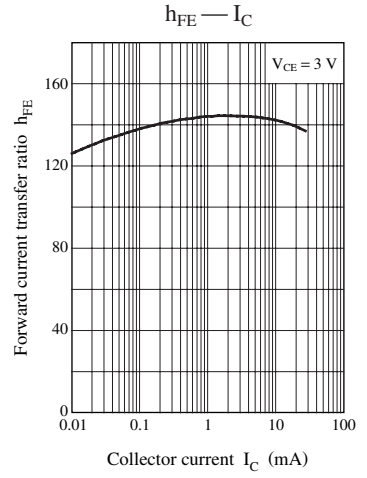
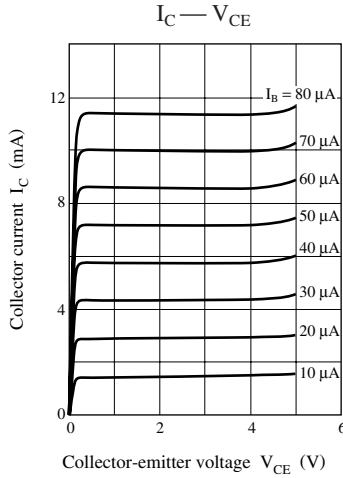
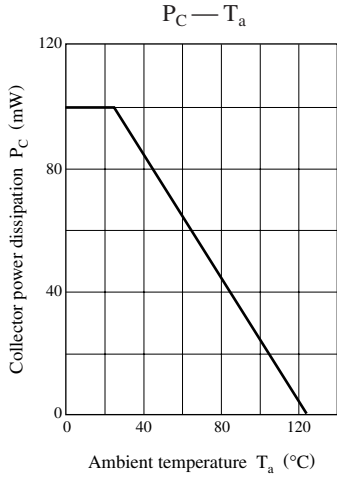
### ■ Electrical Characteristics $T_a = 25^\circ\text{C} \pm 3^\circ\text{C}$

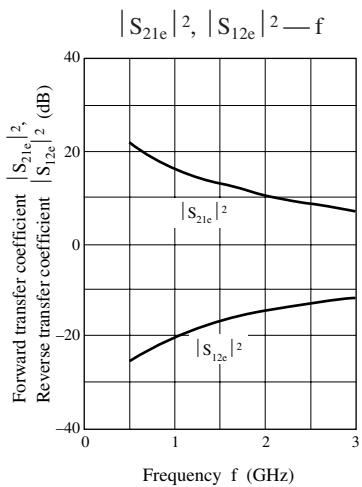
Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Collector-base cutoff current (Emitter open)	$I_{\text{CBO}}$	$V_{\text{CB}} = 9 \text{ V}, I_{\text{E}} = 0$			1	$\mu\text{A}$
Collector-emitter cutoff current (Base open)	$I_{\text{CEO}}$	$V_{\text{CE}} = 6 \text{ V}, I_{\text{B}} = 0$			1	$\mu\text{A}$
Emitter-base cutoff current (Collector open)	$I_{\text{EBO}}$	$V_{\text{EB}} = 1 \text{ V}, I_{\text{C}} = 0$			1	$\mu\text{A}$
Forward current transfer ratio	$h_{\text{FE}}$	$V_{\text{CE}} = 3 \text{ V}, I_{\text{C}} = 6 \text{ mA}$	100		220	—
Transition frequency	$f_{\text{T}}$	$V_{\text{CE}} = 3 \text{ V}, I_{\text{C}} = 20 \text{ mA}, f = 2 \text{ GHz}$		19		GHz
Forward transfer gain	$ S_{21e} ^2$	$V_{\text{CE}} = 3 \text{ V}, I_{\text{C}} = 20 \text{ mA}, f = 2 \text{ GHz}$	7.5	10.5		dB
Noise figure	NF	$V_{\text{CE}} = 3 \text{ V}, I_{\text{C}} = 6 \text{ mA}, f = 2 \text{ GHz}$		1.4	2.0	dB
Collector output capacitance (Common base, input open circuited)	$C_{\text{ob}}$	$V_{\text{CB}} = 3 \text{ V}, I_{\text{E}} = 0, f = 1 \text{ MHz}$		0.4	0.7	pF

Note) Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.



Marking Symbol: 5T





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